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- (71) Applicant (for all designated States except US): **SHOWA DENKO K.K.** [JP/JP]; 13-9, Shibadaimon 1-chome, Minato-ku, Tokyo, 1058518 (JP).
- (72) Inventors; and
- (75) Inventors/Applicants (for US only): **IINO, Tadashi** [JP/JP]; c/o CORPORATE R & D CENTER, SHOWA DENKO K.K., 5-1, Okawacho, Kawasaki-ku, Kawasaki-shi, Kanagawa, 2100858 (JP). **IZUMI, Zenichiro** [JP/JP]; c/o CORPORATE R & D CENTER, SHOWA DENKO K.K., 5-1, Okawacho, Kawasaki-ku, Kawasaki-shi, Kanagawa, 2100858 (JP).
- (74) Agents: **AOKI, Atsushi** et al.; A. Aoki, Ishida & Associates Toranomon 37 Mori Bldg., 5-1, Toranomon 3-chome, Minato-ku, Tokyo 1058423 (JP).
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(54) Title: ELECTROCONDUCTIVE RESIN COMPOSITION AND MOLDED PRODUCT THEREOF

(57) Abstract: An electroconductive resin composition, comprising at least: a multi-component polymer-type resin binder (A) comprising a dispersed phase and a continuous phase, and having a number-average particle size of dispersed phase of 0.001-2 μm , and an electroconductive material (B) in the form of powder and/or fiber. The electroconductive resin composition may preferably be used for a fuel cell separator.

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